





Taimag Corporation

Materials Composition Declaration(MCD) Form

Base Information of Supplier			
Company Name:	炫興股份有限公司	Part No. of	
Tel./FAX No.:	Fax:886-7-3658818	Manufacturer:	RJLDC-308TA(LCP)
Company address:	NO.1,West 2 nd St. N.E.P.Z. Kaohsiung 811 Tai	Manufacturing Site:	CHINA
		Part Description:	RJ45 With LAN Transformer

Materials Composition Spreadsheet				
Location/Usage	Substance Composition	CAS No.:	Weight(mg)	ppm
Housing	LCP	N/A	1750	290257.4
Shield (1) (1660mg)	Cu : 65.58%	7440-50-8	1088.6	180556.7
	Fe : 0.035%	7439-89-6	0.581	96.4
	Zn (Rem.)	7440-66-6	570 Rem.	94541.0
	Pb: 0.007 %	7440-05-3	0.1162	19.3
	Nckel (Planting) 50 u"	7440-02-0	50u"	
Shield (2)	Stainless	N/A	500	82930.7
Contact head	LCP	N/A	485	80442.8
	Cu	7440-50-8	425	70491.1
	Au	7440-57-5	5	829.3
Solder wire	Sn	7440-31-5	95	15756.8
	Sb	7440-36-0	5	829.3
Solder	Sn	7440-31-5	4.34	719.8
	Ag	7440-22-4	0.135	22.4
	Cu	7440-50-8	0.02	3.3
Chip Capacitor		N/A	40	6779.0
Chip Resistor		N/A	8.3	1406.0
PCB	FR4	N/A	200	33898.0
LED	GaP/GaP;GaAsP/GaP	N/A	133	22059.6
CASE	Phenolic Moulding Compoun	169284-22-4	300	49758.4
Pins	Copper	7440-50-8	10.41	1726.6
	Stainless	NA	52.1	8641.4
	Sn	7440-31-5	2.6	431.2
Glue	Epoxy	N/A	112	18576.5
Core	Fe2O3	1345-25-1	77.33	12826.1
	ZnO	1314-13-2	19.37	3212.7
	Powder	N/A	19.24	3191.2
Wire	Copper	7440-50-8	40	6634.5
Solder	Sn	7440-31-5	85.39	14162.9
	Cu	7440-50-8	0.6	99.5
Total package weight(mg):			6029.1322	

The mass of the Transformer and its fractions could be different due to the manufacturing conditions materials.